IGBT - FS, Trench 1200 V, 40 A

FGH40T120SMDL4

Description

Using innovative field stop trench IGBT technology, ON Semiconductor's new series of field stop trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder and PFC applications.

Features

- FS Trench Technology, Positive Temperature Coefficient
- Excellent Switching Performance due to Kelvin Emitter Pin
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V} @ I_C = 40 \text{ A}$
- 100% of the Parts Tested for I_{LM}
- High Input Impedance
- This Device is Pb-Free and is RoHS Compliant

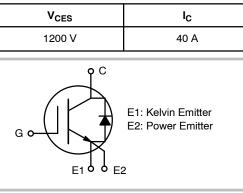
Applications

• Solar Inverter, Welder, UPS and PFC Applications



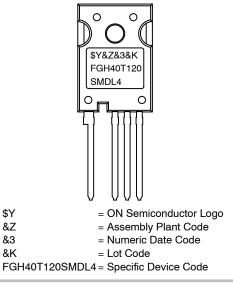
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MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		FGH40T120SMDL4	Unit	
V _{CES}	Collector to Emitter Voltage		1200	V	
V _{GES}	Gate to Emitter Voltage		±25	V	
	Transient Gate to Emitter Voltage		±30	V	
Ι _C	Collector Current	$T_{C} = 25^{\circ}C$	80	А	
		T _C = 100°C	40	А	
I _{LM} (Note 1)	Clamped Inductive Load Current	T _C = 25°C	160	А	
I _{CM} (Note 2)	Pulsed Collector Current		160	А	
١ _F	Diode Continuous Forward Current	T _C = 25°C	80	А	
	Diode Continuous Forward Current	T _C = 100°C	40	А	
I _{FM}	Diode Maximum Forward Current		240	А	
PD	Maximum Power Dissipation	T _C = 25°C	555	W	
		T _C = 100°C	277	W	
TJ	Operating Junction Temperature		–55 to +175	°C	
T _{STG}	Storage Temperature Range		-55 to +175	°C	
ΤL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. $V_{CC} = 600 \text{ V}$, $V_{GE} = 15 \text{ V}$, $I_C = 160 \text{ A}$, $R_G = 20 \Omega$, Inductive Load. 2. Limited by Tjmax.

THERMAL CHARACTERISTICS

Symbol	Parameter	FGH75T65SQDT-F155	Unit
R _{θJC} (IGBT)	Thermal Resistance, Junction to Case	0.27	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	0.89	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Reel Size	Tape Width	Quantity
FGH40T120SMDL4	FGH40T120SMDL4	TO-247-4LD	-	-	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter Test Conditions		Min	Тур	Max	Unit
FF CHARAC	TERISTICS					
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I _C = 250 μ A	1200	-	-	V
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
N CHARACT	TERISTICS					
V _{GE(th)}	G-E Threshold Voltage	I_C = 40 mA, V_{CE} = V_{GE}	4.9	6.2	7.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 25 °C	-	1.8	2.4	V
		I _C = 40 A, V _{GE} = 15 V, T _C = 175°C	-	2.0	-	V
YNAMIC CH	ARACTERISTICS				•	
Cies	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1MHz	-	4300	-	pF
C _{oes}	Output Capacitance	f = 1MHz	-	180	-	pF
C _{res}	Reverse Transfer Capacitance		-	100	-	pF
WITCHING C	CHARACTERISTICS				•	
T _{d(on)}	Turn–On Delay Time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A},$ $R_{G} = 10 \Omega, \text{ V}_{GE} = 15 \text{ V},$ Inductive Load, $T_{C} = 25^{\circ}\text{C}$	-	44	-	ns
Tr	Rise Time		-	42	-	ns
T _{d(off)}	Turn-Off Delay Time		-	464	-	ns
Τ _f	Fall Time		-	24	-	ns
Eon	Turn-On Switching Loss		-	2.24	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.02	-	mJ
E _{ts}	Total Switching Loss		-	3.26	-	mJ
T _{d(on)}	Turn–On Delay Time	V _{CC} = 600 V, I _C = 40 A, R _G = 10 Ω, V _{GE} = 15 V,	-	42	-	ns
Tr	Rise Time	Inductive Load, $T_C = 25^{\circ}C$	-	48	-	ns
T _{d(off)}	Turn-Off Delay Time		-	518	-	ns
Τ _f	Fall Time		-	24	-	ns
Eon	Turn-On Switching Loss		-	3.11	-	mJ
E _{off}	Turn-Off Switching Loss		-	2.01	-	mJ
E _{ts}	Total Switching Loss		-	5.12	-	mJ
Qg	Total Gate Charge	$V_{CE} = 600 \text{ V}, I_{C} = 40 \text{ A},$	-	370	_	nC
Q _{ge}	Gate to Emitter Charge	V _{GE} = 15 V	-	23	-	nC
Q _{gc}	Gate to Collector Charge		-	210	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 40 A	T _C = 25°C	-	3.8	4.8	V
			T _C = 175°C	-	2.7	-	
T _{rr}		V _R = 600 V, I _F = 40 A di _F /dt = 200 A/µs, T _C = 25°C		-	65	-	ns
I _{rr}	Diode Peak Reverse Recovery Current	ui _F /ut = 200 Α/μS,	-	7.2	-	А	
Q _{rr}	Diode Reverse Recovery Charge			-	234	-	nC
T _{rr}		V _R = 600 V, I _F = 40 A di _F /dt = 200 A/μs, T _C = 175°C		-	200	-	ns
I _{rr}	Diode Peak Reverse Recovery Current			-	18.0	-	А
Q _{rr}	Diode Reverse Recovery Charge			-	1800	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

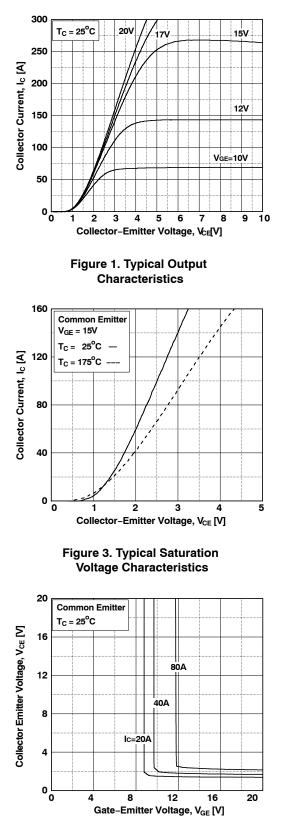


Figure 5. Saturation Voltage vs. V_{GE}

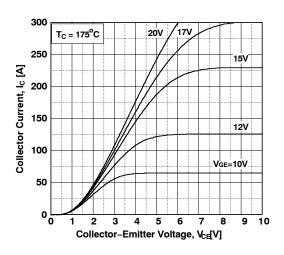


Figure 2. Typical Output Characteristics

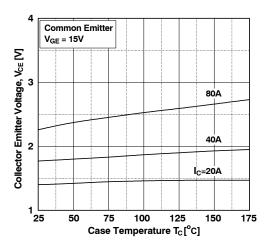


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

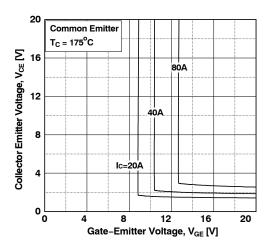


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

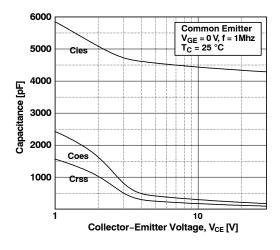
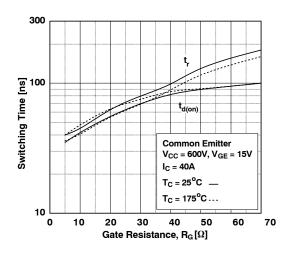


Figure 7. Capacitance Characteristics





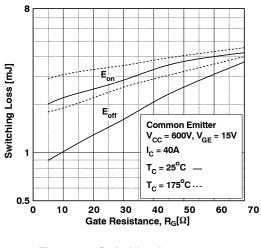


Figure 11. Switching Loss vs. Gate Resistance

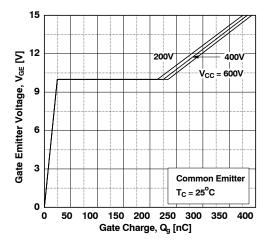


Figure 8. Gate Charge Characteristics

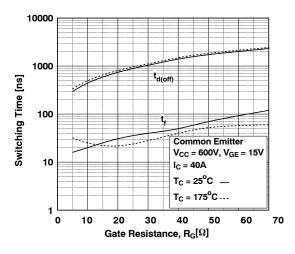
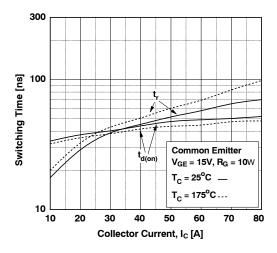
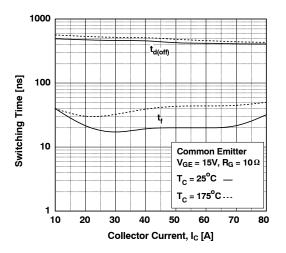


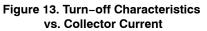
Figure 10. Turn-off Characteristics vs. Gate Resistance





TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





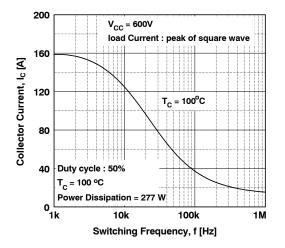


Figure 15. Load Current vs. Frequency

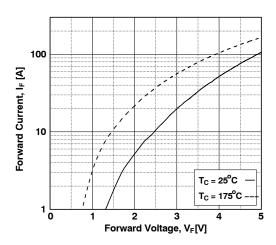


Figure 17. Forward Characteristics

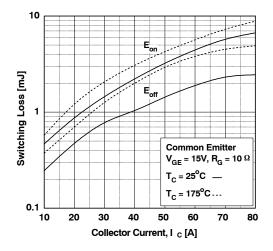


Figure 14. Switching Loss vs. Collector Current

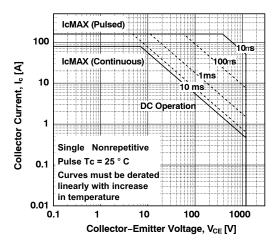


Figure 16. SOA Characteristics

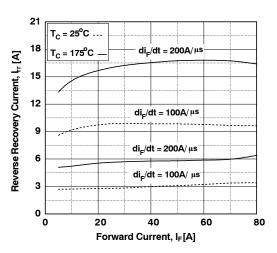


Figure 18. Reverse Recovery Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

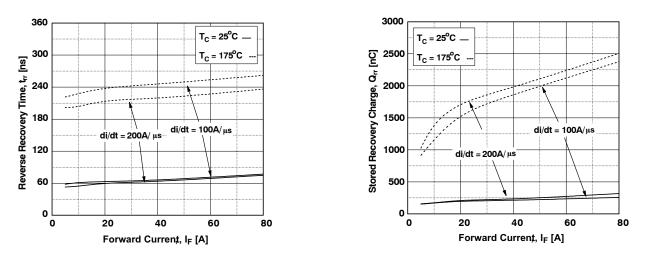


Figure 19. Reverse Recovery Time



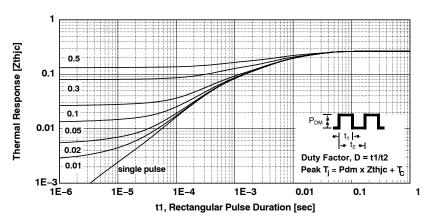


Figure 21. Transient Thermal Impedance of IGBT

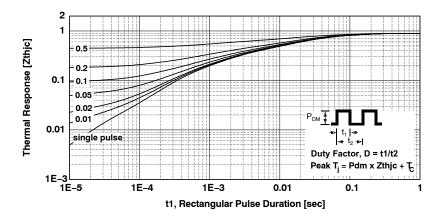


Figure 22. Transient Thermal Impedance of Diode



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

NOM

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2.40

2.00

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1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

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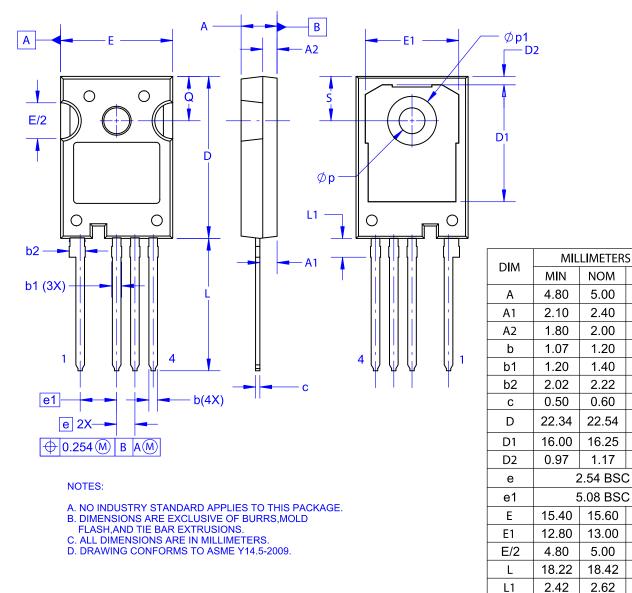
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